507558850 10/24/2022 PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7605739

SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY	DATA				
		Name	Execution Date		
TAKERU TSUZUKI			11/07/2018		
KATSUMI NISHIKOR			11/08/2018		
RECEIVING PARTY I	DATA				
Name:	SONY	SEMICONDUCTOR SOLUTIONS	CORPORATION		
Street Address:	4-14-1	ASAHI-CHO			
Internal Address:	ATSUC	âl-SHI			
City:	KANA	GAWA			
State/Country:	JAPAN	JAPAN			
Postal Code:	243-00	14			
Property Typ		Number			
Property Typ Application Number:		Number 17090666			
Application Number	:				
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Application Number: CORRESPONDENCE Fax Number: <i>Correspondence will using a fax number,</i> Phone: Email: Correspondent Name	E DATA I be sent to if provideo	17090666 (303)863-0223 o the e-mail address first; if that i d; if that is unsuccessful, it will b 303-863-9700 sony@sheridanross.com SHERIDAN ROSS P.C.	,		
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Application Number: CORRESPONDENCE Fax Number: Correspondence will using a fax number, Phone: Email: Correspondent Name Address Line 1: Address Line 2:	E DATA I be sent to if provideo	17090666 (303)863-0223 b the e-mail address first; if that i d; if that is unsuccessful, it will b 303-863-9700 sony@sheridanross.com SHERIDAN ROSS P.C. 1560 BROADWAY SUITE 1200	e sent via US Mail.		
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Attorney Docket No.: Sony Ref. No.: SP366897US00

, with offices at

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title	of
Inver	ition

SOLID-STATE IMAGE PICKUP APPARATUS, CORRECTION METHOD, AND ELECTRONIC APPARATUS

As the below named inventor, I hereby declare that:

This declaration is directed to:

The attached application, or

United States application or PCT international application number PCT/JP2017/022986 filed on 2017/06/22

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION

<u>4~14~1 Asahi~cho, Atsugi-shi, Kanagawa, Japan</u> (hereinafter referred to as ASSIGNEE), is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and tegal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL N	AME OF INVENTOR		
Inventor:	TAKERU TSUZUKI	Date:	20/8/11/7
Signature:	Jakeru Truzeki		

PATENT REEL: 061513 FRAME: 0898

Attorney Docket No.: Sony Ref. No.: SP366897US00

, with offices at

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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and countries foreign thereto, the filing of applications for patents or securing of patents in the United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as said ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

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LEGAL N/	AME OF INVENTOR		
inventor:	KATSUMÉNISHIKORI	 Date:	2018/11/8
Signature:	Katami Mdikon	 	

RECORDED: 10/24/2022